



PATENTS

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**Applicant(s):** Noriaki Oda, et al.

**Examiner:** Monica Lewis

**Serial No:** 09/863,737

**Art Unit:** 2822

**Filed:** May 23, 2001

**Docket:** 12562A

**For:** SEMICONDUCTOR DEVICE AND  
METHOD FOR MANUFACTURING  
THE SAME

**Dated:** December 30, 2002

Assistant Commissioner for Patents  
Washington, D.C. 20231

10# / Amndt C  
1/14/03  
elbm

**AMENDMENT AND RESPONSE TO OFFICE ACTION**

Sir:

In response to the Office Action dated August 28, 2002, applicants submit  
the following Amendment for entry in the above-identified case.

**IN THE CLAIMS:**

✓ Please cancel Claims 2 and 6 without prejudice.

Please amend Claims 1, 3, 5 and 7 as follows:

sub 07 C.1  
1. (Amended) A semiconductor device having a plurality of wirings  
juxtaposed with one another and a SiOF insulating film being in contact with the wirings,

**CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)**

I hereby certify that this correspondence is being deposited with the United States  
Postal Service as first class mail in an envelope addressed to: Assistant Commissioner  
for Patents, Washington, D.C. 20231 on December 30, 2002.

Dated: December 30, 2002

Janet Grossman  
Janet Grossman